1-826942-6 - ACTIVE

### AMPMODU | AMPMODU Headers

TE Internal #: 1-826942-6 PCB Mount Header, Vertical, Board-to-Board, 32 Position, 2.54 mm [.1 in] Centerline, Breakaway, Tin, Through Hole - Solder, Signal, AMPMODU Headers

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PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **32** 

Number of Rows: 2

## Features

## Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Breakaway

Sealable	No				
Connector & Contact Terminates To	Printed Circuit Board				
Configuration Features					
Connector Contact Load Condition	Fully Loaded				
PCB Mount Orientation	Vertical				
Number of Positions	32				
Number of Rows	2				
Board-to-Board Configuration	Parallel				
Electrical Characteristics					
Insulation Resistance	5000 MΩ				
Dielectric Withstanding Voltage (Max)	750 Vrms				
Body Features					
Primary Product Color	Green				
Contact Features					
Mating Square Post Dimension	.64 mm[.025 in]				

**C** For support call+1 800 522 6752

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PCB Contact Termination Area Plating Material Thickness	2 µm	
Contact Shape & Form	Square	
Contact Underplating Material	Nickel	
PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Phosphor Bronze	
Contact Mating Area Plating Material	Tin	
Contact Mating Area Plating Material Thickness	3 μm[118.11 μin]	
Contact Type	Pin	
Contact Current Rating (Max)	5 A	
Termination Features		
Square Termination Post & Tail Dimension	.64 mm[.025 in]	
Termination Post & Tail Length	3.2 mm[.126 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mating Alignment	Without	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	
Housing Features		
Centerline (Pitch)	2.54 mm[.1 in]	
Housing Material	PBT	
Dimensions		
Row-to-Row Spacing	2.54 mm[.1 in]	
PCB Thickness (Recommended)	1.57 mm[.062 in]	
Usage Conditions		
Housing Temperature Rating	Standard	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]	
Operation/Application		
Circuit Application	Signal	
Industry Standards		
UL Flammability Rating	UL 94V-0	
Packaging Features		

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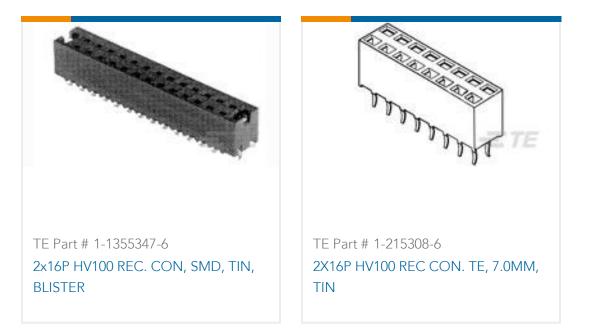


Packaging Quantity	200	
Packaging Type	Carton	
Product Compliance		
For compliance documentation, visit the product page on TE.com>		
EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023	
	(235)	
	Candidate List Declared Against: JAN 2023 (233)	
	Does not contain REACH SVHC	
Halogen Content	Not Low Halogen - contains Br or Cl > 900	
	ppm.	
Solder Process Capability	Wave solder capable to 265°C	

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**

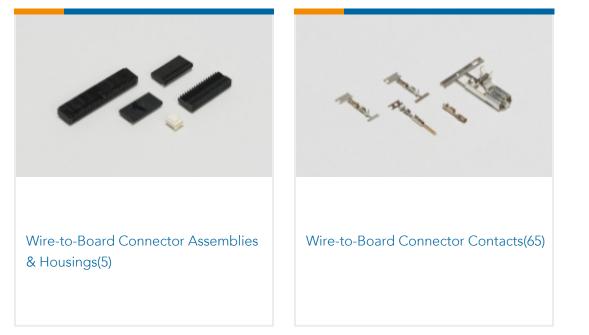


Also in the Series AMPMODU Headers

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# Customers Also Bought



TE Part #T4131412041-000 M12,REAR MOUNT,FEMALE,B,4P, SOLDER WIRE	TE Part #T4111401041-000 M12,MALE,STRAIGHT,B CODE,4P, PG7,GOLD	TE Part #342144-1 16-14 F.E.P/G RING TONGUE	TE Part #1623440-1 CRG1206 1% 1K0	
201 100 100 100 100 100 100 100 100 100			TTE	
TE Part #2176326-1 CRGP 0603 10R 1%	TE Part #6-2176328-1 CRGP 1206 1M0 1%	TE Part #534206-9 18 MODII VRT DR CE 100/115	TE Part #5-2176525-2 3503G 2B 20K 1% 1K RL	



## Documents

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Product Drawings 16P MOD2 STIFT LEI

English

16P MOD2 STIFT LEI

English

Agency Approvals

UL Report

English